IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

CERTIFICATE OF EXPRESS MAILING

I hereby certify that this paper and the documents and/or fees referred to as attached therein are being deposited with the United States Postal Service on November 20, 2003in an envelope as "Express Mail Post Office to Addressee" service under 37 CFR §1.10, Mailing Label Number EV 332826158 US, addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Ryan Eachus

Attorney Docket No.: ALTRP100/A1198

First Named Inventor: Wen-chou Vincent

Wang et al.

UTILITY PATENT APPLICATION TRANSMITTAL (37 CFR. § 1.53(b))

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Assigned to: Altera Corporation

Sir: This is a request for filing a patent application under 37 CFR. § 1.53(b) in the name of inventors:

WEN-CHOU VINCENT WANG and YUAN LI

For: STRUCTURE, MATERIAL, AND DESIGN FOR ASSEMBLING A LOW-K SI DIE TO ACHIEVE AN INDUSTRIAL GRADE RELIABILITY WIRE BONDING PACKAGE

Application Elements: 26 Pages of Specification, Claims and Abstract (including cover sheet) 08 Sheets of formal Drawings 02 Pages executed Declaration Accompanying Application Parts: Do not publish this application. Nonpublication Request is attached. Assignment and Assignment Recordation Cover Sheet (recording fee of \$40.00 enclosed) 37 CFR 3.73(b) Statement by Assignee Information Disclosure Statement with Form PTO-1449 Copies of IDS Citations Preliminary Amendment Return Receipt Postcard

Other:

| Claim For | Foreign Priority | | | | | |
|---|---|---------------|---|---------------------------|------------|---|
| Pri | is claimed unde The certification The certification | ied copy is | § 119. enclosed. s been filed in prior app | olication U.S. Ap | oplication | No. |
| Fee Calcu | lation (37 CFR § 1. | <u>16)</u> | | | | |
| Ap | plicant is entitled to | Small Ent | ity Status under 37 C.F | C.R. §1.27. | • | |
| | (Col. 1) Total Claims | | (Col. 2) Claims | (Col. 3) Present Extra | Rate | Additional Fee |
| TOTAL | 33 | MINUS | 20 | 13 | x 18 = | 234.00 |
| INDEP. | 3 | MINUS | 3 | 0 | x 86 = | 0 |
| [] First presentation of multiple dependent claim \$280 = | | | | | | |
| Basic Filing Fee under 37 C.F.R. §1.16(a) \$770 = | | | | | | 770.00 |
| TOTAL | | | | | | 1,004.00 |
| SMALL ENTITY 50% FILING FEE REDUCTION (if applicable) | | | | | | |
| The C | commissioner is aut | horized to c | f \$1,044.00 is enclosed charge any fees beyond Deposit Account No. | the amount encl | osed which | ch may be LP100). |
| General A | uthorization for Pet | ition for Ex | tension of Time (37 Cl | FR §1.136) | | |
| for any sub | osequent filings. Th | ne Commiss | ly authorize any Petitic sioner is also authorize ant No. 500388 (Order | d to charge any e | extension | e as may be needed fees under 37 CFR |
| Neas | se send corresponde | nce to the fe | ollowing address: | | | |
| | | Cus | stomer Number 022 | 2434 | | |
| Date: Nov | vember 20, 2003 | | Desmund Gean Registration No. 52 | Lean 2,937 | | |

Page 2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Wen-chou Vincent Wang et

al.

Attorney Docket No.: ALTRP100/A1198

Application No.: Please assign

Examiner: Please assign

Group: Please assign

Filed: Herewith

Title: STRUCTURE, MATERIAL, AND

DESIGN FOR ASSEMBLING A LOW-K SI DIE

TO ACHIEVE AN INDUSTRIAL GRADE RELIABILITY WIRE BONDING PACKAGE

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NONPUBLICATION REQUEST AND CERTIFICATION (35 U.S.C. 122(b)(2)(B)(i))

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen (18) months after filing. I hereby request that the attached application NOT be published under 35 U.S.C. 122(b).

Date: Nov. 20, 2003

Desmund Gean

Registration No. 52,937

NOTE:

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications, eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign of international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).